# AH118 / ECG099 1/4 Watt, High Linearity InGaP HBT Amplifier Product Information



### **Product Features**

- 60 3500 MHz
- +24.7 dBm P1dB
- +40.5 dBm Output IP3
- 20.4 dB Gain @ 900 MHz
- 16.5 dB Gain @ 1900 MHz
- +5V Single Positive Supply
- Available in lead-free / green SOT-89 SMT Package Style

### **Applications**

- · Final stage amplifiers for Repeaters
- Mobile Infrastructure
- DBS / WLL / W-LAN
- Defense / Homeland Security

### Specifications<sup>(1)</sup>

Parameter	Units	Min	Тур	Max
Operational Bandwidth	MHz	60		3500
Test Frequency	MHz		1900	
Gain	dB	13.5	16.5	
Input Return Loss	dB		12	
Output Return Loss	dB		18	
Output P1dB	dBm	+23	+24.7	
Output IP3 <sup>(2)</sup>	dBm	+39.5	+40.5	
IS-95A Channel Power @ -45 dBc ACPR	dBm		+18	
W-CDMA Channel Power @ -45 dBc ACLR, 2140 MHz	dBm		+16.7	
Noise Figure	dB		4.3	
Operating Current Range	mA	140	160	175
Device Voltage	V		+5	

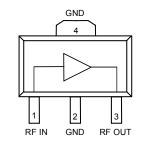
Test conditions unless otherwise noted: 25°C, Vsupply = +5 V, in tuned application circuit.
30IP measured with two tones at an output power of +11 dBm/tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the 30IP using a 2:1 rule.

### **Product Description**

The AH118 / ECG099 is a high dynamic range driver amplifier in a low-cost surface mount package. The InGaP/GaAs HBT is able to achieve high performance across a broad range with +40.5 dBm OIP3 and +24.7 dBm of compressed 1dB power. The AH118 / ECG099 is available in a lead-free/green/RoHS-compliant SOT-89 package. All devices are 100% RF and DC tested.

The AH118 / ECG099 is targeted for use as a driver amplifier in wireless infrastructure where high linearity and medium power is required. Internal biasing allows the AH118 to maintain high linearity over temperature and operate directly off a single +5V supply. This combination makes the device an excellent candidate for transceiver line cards in current and next generation multi-carrier 3G base stations.

### **Functional Diagram**



Function	Pin No.
Input / Base	1
Output / Collector	3
Ground	2,4

### Typical Performance (3)

Parameter	Units		Typical	
Frequency	MHz	900	1900	2140
S21 - Gain	dB	20.4	16.5	16.3
S11 - Input R.L.	dB	-15	-12	-15
S22 - Output R.L.	dB	-12	-18	-16
Output P1dB	dBm	+24.2	+24.7	+24.7
Output IP3	dBm	+40	+40.5	+40.5
IS-95A Channel Power @ -45 dBc ACPR,	dBm	+18.2	+18	
W-CDMA Channel Power @ -45 dBc ACLR	dBm			+16.7
Noise Figure	dB	4.0	4.3	4.8
Supply Bias		+5	V @ 160 :	mA

3. Typical parameters reflect performance in a tuned application circuit: Vsupply = +5 V. I = 160 mA, +25° C

### **Absolute Maximum Rating**

Parameter	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-65 to +150 °C
RF Input Power (continuous)	+15 dBm
Device Voltage	+6 V
Device Current	220 mA
Junction Temperature	+250 °C

Operation of this device above any of these parameters may cause permanent damage.

## **Ordering Information**

Part No.	Description
AH118-89*	High Linearity InGaP HBT Amplifier (lead-tin SOT-89 Pkg)
ECG099B*	High Linearity InGaP HBT Amplifier (lead-tin SOT-89 Pkg)
AH118-89G	High Linearity InGaP HBTAmplifier (lead-free/green/RoHS-compliant SOT-89 Pkg)
AH118-89PCB900	900 MHz Evaluation Board
AH118-89PCB1900	1900 MHz Evaluation Board
AH118-89PCB2140	2140 MHz Evaluation Board

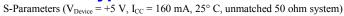
This package is being phased out in favor of the green package type which is backwards compatible for existing designs. Refer to Product Change Notification WJPCN06MAY05TC1 on the WJ website Specifications and information are subject to change without notice

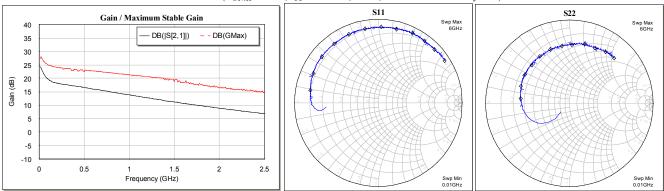
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**Product Information** 

#### **Typical Device Data**





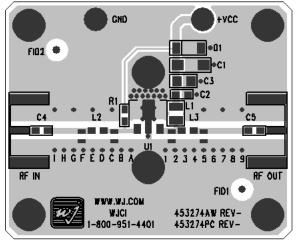
Notes:

The gain for the unmatched device in 50 ohm system is shown as the trace in black color. For a tuned circuit for a particular frequency, it is expected that actual gain will be higher, up to the maximum stable gain. The maximum stable gain is shown in the dashed red line. The impedance plots are shown from 50 - 6000 MHz, with markers placed at 0.5 - 6.0 GHz in 0.5 GHz increments.

S-Parameters (	$V_{\text{Device}} = +5 \text{ V},$	$I_{CC} = 160 \text{ mA}, 2$	25°C, unmatche	d 50 ohm syste	m, calibrated to	device leads)
Frea (MHz)	S11 (dB)	S11 (ang)	S21 (dB)	S21 (ang)	S12 (dB)	S12 (ang)

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Freq (MHz)	S11 (dB)	S11 (ang)	S21 (dB)	S21 (ang)	S12 (dB)	S12 (ang)	S22 (dB)	S22 (ang)
50	-2.69	-173.38	21.74	153.70	-31.02	11.24	-7.02	-148.17
100	-2.16	-177.19	19.63	150.82	-30.31	7.90	-5.57	-162.45
200	-1.91	178.30	18.22	148.19	-29.87	5.01	-5.06	-173.51
400	-1.77	172.47	17.13	135.41	-29.83	4.07	-4.77	177.87
600	-1.60	166.83	15.99	121.91	-29.49	2.79	-4.60	171.65
800	-1.45	161.09	14.97	109.02	-29.18	2.11	-4.44	166.08
1000	-1.40	155.39	13.84	97.28	-28.70	1.64	-4.26	160.40
1200	-1.25	149.59	12.76	86.83	-28.63	-0.09	-4.14	155.01
1400	-1.20	143.79	11.71	76.95	-28.30	-1.34	-3.97	149.63
1600	-1.17	137.57	10.63	68.15	-27.94	-4.47	-4.00	144.03
1800	-1.13	132.05	9.75	59.55	-27.63	-7.00	-3.86	139.02
2000	-1.11	126.72	8.88	52.22	-27.51	-8.43	-3.84	134.24
2200	-1.05	121.50	8.00	45.09	-27.06	-11.00	-3.62	129.30
2400	-0.99	115.58	7.31	37.40	-27.02	-14.19	-3.55	124.42
2600	-0.93	110.41	6.52	30.66	-26.78	-18.24	-3.46	119.42
2800	-0.95	105.30	5.73	23.51	-26.66	-20.10	-3.34	114.26
3000	-0.92	100.11	5.05	17.07	-26.61	-23.28	-3.30	109.29

### **Application Circuit PC Board Layout**



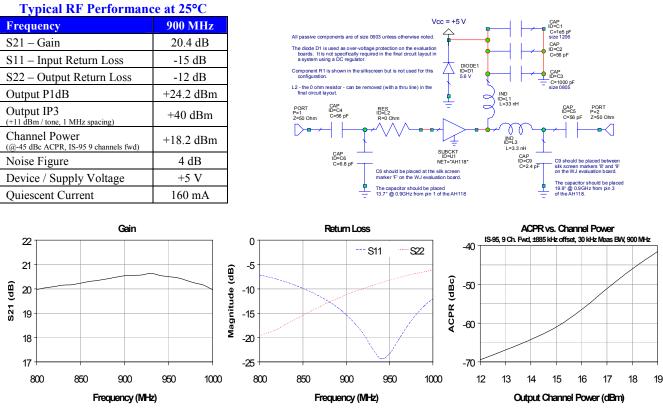
Circuit Board Material: .062" total thickness with a .014" Getek top RF layer, 4 layers (other layers added for rigidity), 1 oz copper, Microstrip line details: width =  $.026^{\circ}$ , spacing =  $.026^{\circ}$ The silk screen markers 'A', 'B', 'C', etc. and '1', '2', '3', etc. are used as placemarkers for the input and output tuning.

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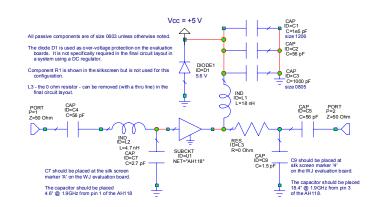
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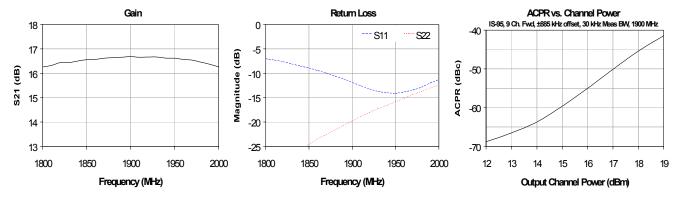
### 900 MHz Application Circuit (AH118-89PCB900)



1900 MHz Application Circuit (AH118-89PCB1900)

Typical RF Performance at 25°C		
Frequency	1900 MHz	
S21 – Gain	16.5 dB	
S11 – Input Return Loss	-12 dB	
S22 – Output Return Loss	-18 dB	
Output P1dB	+24.7 dBm	
Output IP3 (+11 dBm / tone, 1 MHz spacing)	+40.5 dBm	
Channel Power (@-45 dBc ACPR, IS-95 9 channels fwd)	+18 dBm	
Noise Figure	4.3 dB	
Device / Supply Voltage	+5 V	
Quiescent Current	160 mA	





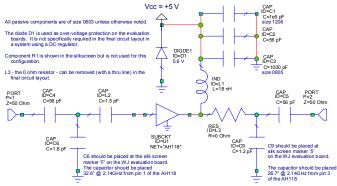
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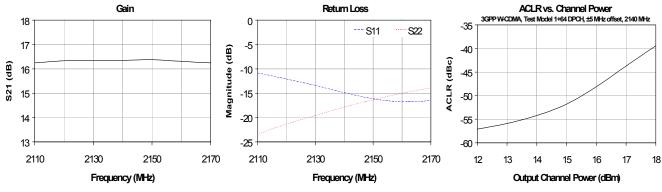


**Product Information** 

### 2140 MHz Application Circuit (AH118-89PCB2140)

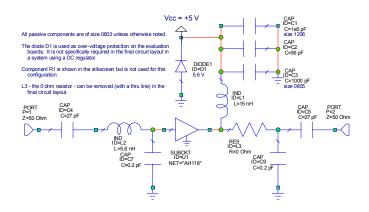
Typical RF Performan	ce at 25°C	
Frequency	2140 MHz	
S21 – Gain	16.3 dB	All passive components are of size 0603 unless otherwise no The diode D1 is used as over-voltage protection on the evalu
S11 – Input Return Loss	-15 dB	boards. It is not specifically required in the final circuit layo a system using a DC regulator.
S22 – Output Return Loss	-16 dB	Component R1 is shown in the silkscreen but is not used for configuration.
Output P1dB	+24.7 dBm	L3 - the 0 ohm resistor - can be removed (with a thru line) in t final circuit layout.
Output IP3 (+11 dBm / tone, 1 MHz spacing)	+40.5 dBm	PORT CAP CAP P=1 ID=C4 ID=L2 Z=50 Ohm C=56 pF C=1.5 pF
Channel Power (@-45 dBc ACPR, IS-95 9 channels fwd)	+16.7 dBm	
Noise Figure	4.8 dB	CAP ID=C6 C=1.8 pF
Device / Supply Voltage	+5 V	C6 should be placed at th marker 'F' on the WJ eval _ The capacitor should be p
Quiescent Current	160 mA	





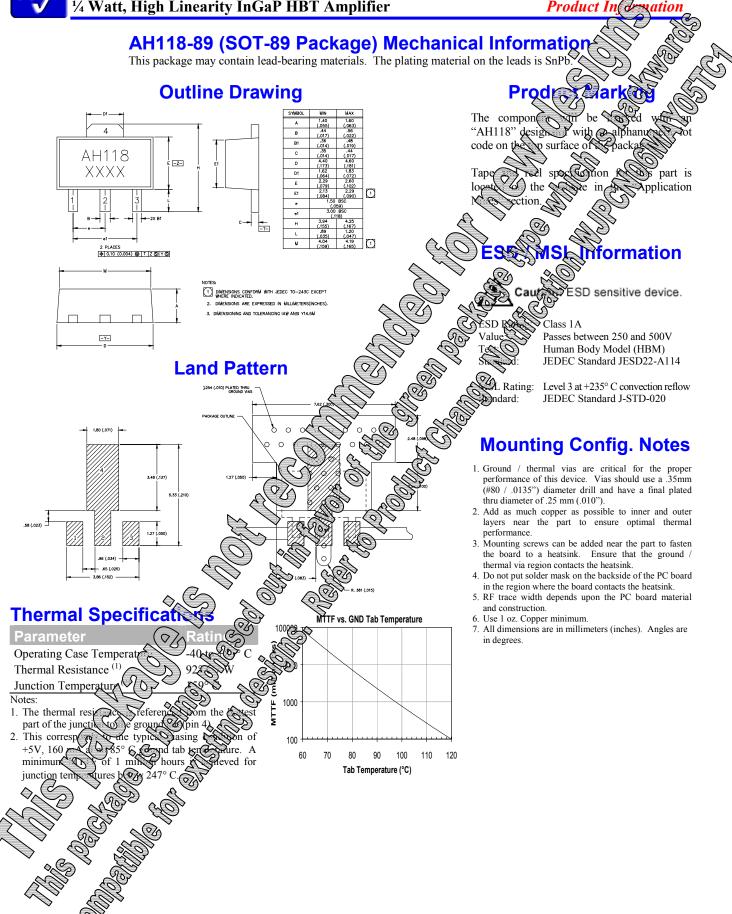
### **3500 MHz Application Circuit**

Typical RF Performance at 25°C		
Frequency	3500 MHz	
S21 – Gain	8.5 dB	
S11 – Input Return Loss	-12 dB	
S22 – Output Return Loss	-12 dB	
Output P1dB	+23.5 dBm	
Output IP3 (+11 dBm / tone, 1 MHz spacing)	+38.5 dBm	
Noise Figure	5.0 dB	
Device / Supply Voltage	+5 V	
Quiescent Current	160 mA	





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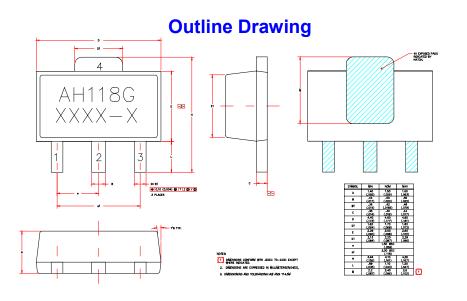
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**Product Information** 

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### AH118-89G (Green / Lead-free SOT-89 Package) Mechanical Information

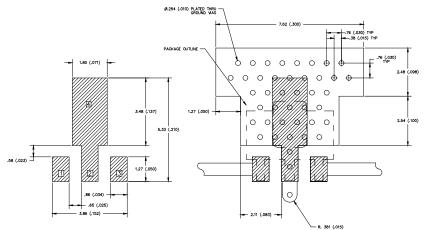
This package is lead-free/Green/RoHS-compliant. It is compatible with both lead-free (maximum 260°C reflow temperature) and leaded (maximum 245°C reflow temperature) soldering processes. The plating material on the leads is NiPdAu.



AH118 / ECG099

<sup>1</sup>/<sub>4</sub> Watt, High Linearity InGaP HBT Amplifier

### Land Pattern

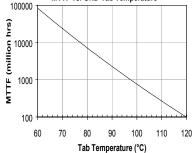


### **Thermal Specifications**

Parameter	Rating
Operating Case Temperature	-40 to +85° C
Thermal Resistance <sup>(1)</sup>	92° C / W
Junction Temperature <sup>(2)</sup>	159° C
Notes:	

- 1. The thermal resistance is referenced from the hottest part of the junction to the ground tab (pin 4).
- This corresponds to the typical biasing condition of +5V, 160 mA at an 85° C ground tab temperature. A minimum MTTF of 1 million hours is achieved for junction temperatures below 247° C.

#### MTTF vs. GND Tab Temperature



### **Product Marking**

The component will be marked with an "AH118G" designator with an alphanumeric lot code on the top surface of the package.

Tape and reel specifications for this part are located on the website in the "Application Notes" section.

### **MSL / ESD Rating**

Caution! ESD sensitive device.

ESD Rating:	Class 1A
Value:	Passes between 250 and 500V
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114

MSL Rating: Level 3 at +260° C convection reflow Standard: JEDEC Standard J-STD-020

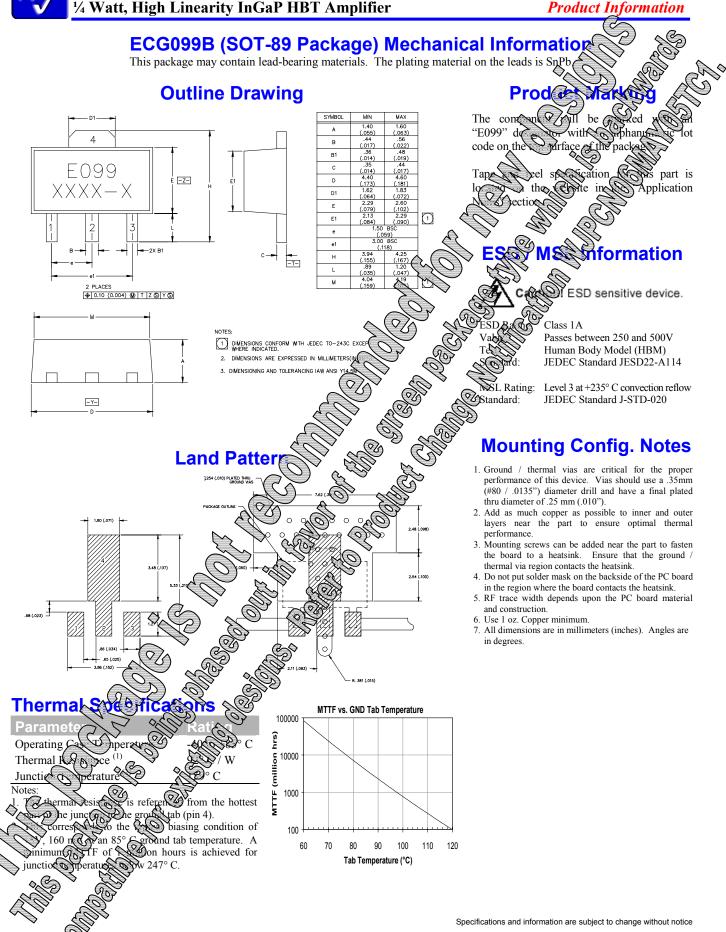
### **Mounting Config. Notes**

- Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
- 4. Do not put solder mask on the backside of the PC board in the region where the board contacts the heatsink.
- RF trace width depends upon the PC board material and construction.
- 6. Use 1 oz. Copper minimum.
- 7. All dimensions are in millimeters (inches). Angles are in degrees.

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